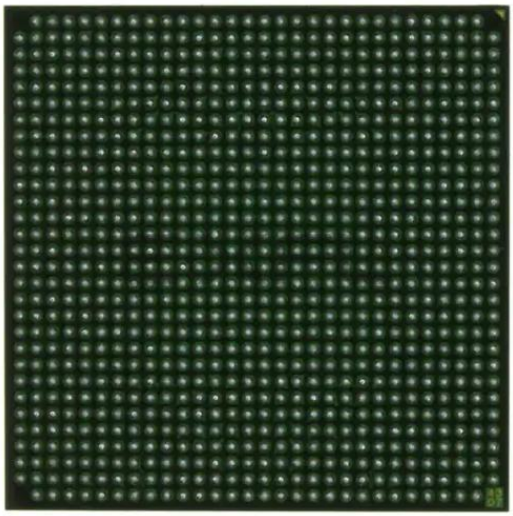

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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	1920
Number of Logic Elements/Cells	-
Total RAM Bits	884736
Number of I/O	528
Number of Gates	1500000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	896-BBGA, FCBGA
Supplier Device Package	896-FCBGA (31x31)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2v1500-4ff896i

Routing

DCM Locations/Organization

Virtex-II DCMs are placed on the top and bottom of each block RAM and multiplier column. The number of DCMs depends on the device size, as shown in Table 24.

Table 24: **DCM Organization**

Device	Columns	DCMs
XC2V40	2	4
XC2V80	2	4
XC2V250	4	8
XC2V500	4	8
XC2V1000	4	8
XC2V1500	4	8
XC2V2000	4	8
XC2V3000	6	12
XC2V4000	6	12
XC2V6000	6	12
XC2V8000	6	12

Active Interconnect Technology

Local and global Virtex-II routing resources are optimized for speed and timing predictability, as well as to facilitate IP cores implementation. Virtex-II Active Interconnect Technology is a fully buffered programmable routing matrix. All routing resources are segmented to offer the advantages of a hierarchical solution. Virtex-II logic features like CLBs, IOBs, block RAM, multipliers, and DCMs are all connected to an identical switch matrix for access to global routing resources, as shown in Figure 47.

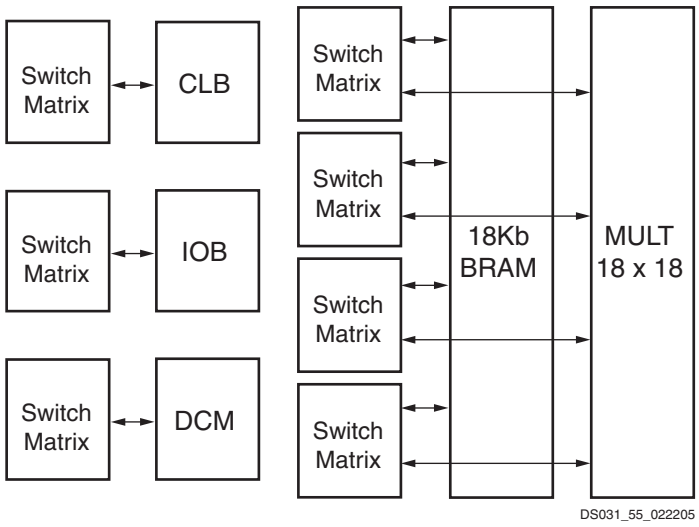

Figure 47: **Active Interconnect Technology**

Each Virtex-II device can be represented as an array of switch matrixes with logic blocks attached, as illustrated in Figure 48.

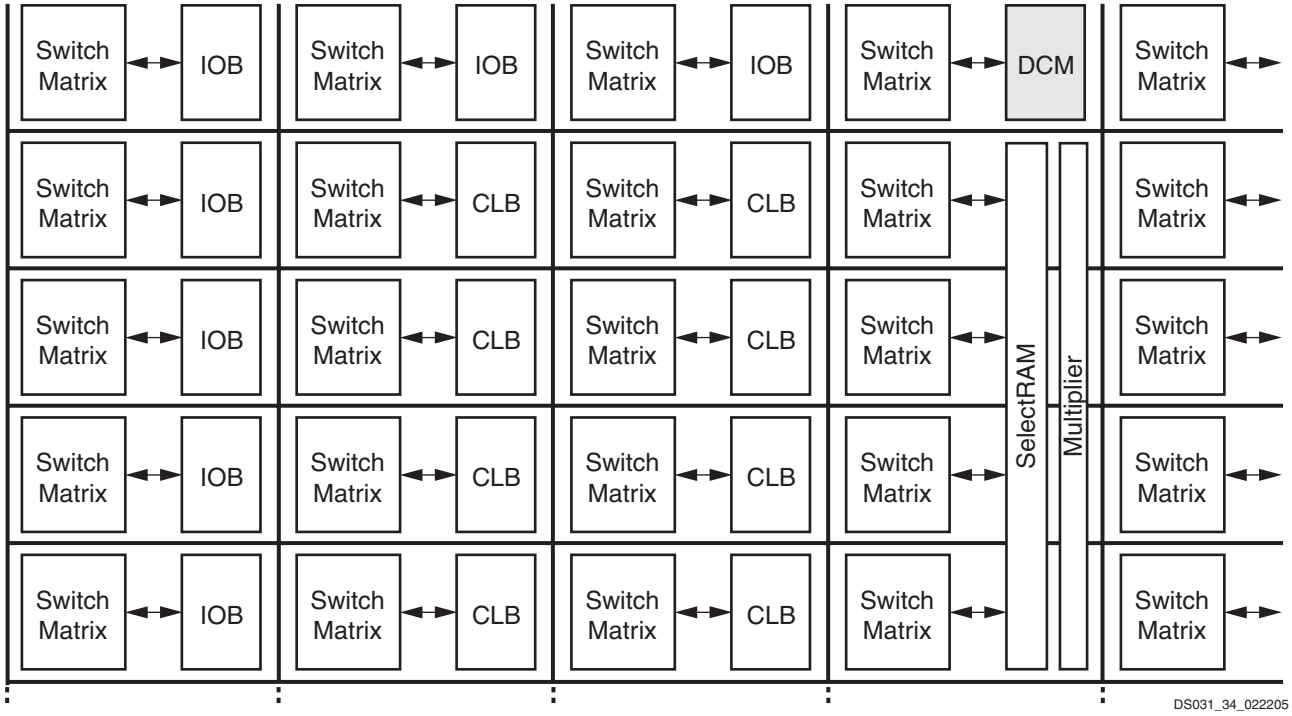

Figure 48: **Routing Resources**

The Virtex-II implementation process is comprised of Synthesis, translation, mapping, place and route, and configuration file generation. While the tools can be run individually, many designers choose to run the entire implementation process with the click of a button. To assist those who prefer to script their design flows, Xilinx provides Xflow, an automated single command line process.

Design Verification

In addition to conventional design verification using static timing analysis or simulation techniques, Xilinx offers powerful in-circuit debugging techniques using ChipScope ILA (Integrated Logic Analysis). The reconfigurable nature of Xilinx FPGAs means that designs can be verified in real time without the need for extensive sets of software simulation vectors.

For simulation, the system extracts post-layout timing information from the design database, and back-annotates this information into the netlist for use by the simulator. The back annotation features a variety of patented Xilinx techniques, resulting in the industry's most powerful simulation flows. Alternatively, timing-critical portions of a design can be verified using the Xilinx static timing analyzer or a third party static timing analysis tool like Synopsys Prime Time™, by exporting timing data in the STAMP data format.

For in-circuit debugging, ChipScope ILA enables designers to analyze the real-time behavior of a device while operating at full system speeds. Logic analysis commands and captured data are transferred between the ChipScope software and ILA cores within the Virtex-II FPGA, using industry standard JTAG protocols. These JTAG transactions are driven over an optional download cable (MultiLINX or JTAG), connecting the Virtex device in the target system to a PC or workstation.

ChipScope ILA was designed to look and feel like a logic analyzer, making it easy to begin debugging a design immediately. Modifications to the desired logic analysis can be downloaded directly into the system in a matter of minutes.

Other Unique Features of Virtex-II Design Flow

Xilinx design flows feature a number of unique capabilities. Among these are efficient incremental HDL design flows; a robust capability that is enabled by Xilinx exclusive hierarchical floorplanning capabilities. Another powerful design capability only available in the Xilinx design flow is "Modular Design", part of the Xilinx suite of team design tools, which enables autonomous design, implementation, and verification of design modules.

Incremental Synthesis

Xilinx unique hierarchical floorplanning capabilities enable designers to create a programmable logic design by isolating design changes within one hierarchical "logic block", and perform synthesis, verification and implementation processes on that specific logic block. By preserving the logic in unchanged portions of a design, Xilinx incremental design makes the high-density design process more efficient.

Xilinx hierarchical floorplanning capabilities can be specified using the high-level floorplanner or a preferred RTL floorplanner (see the Xilinx web site for a list of supported EDA partners). When used in conjunction with one of the EDA partners' floorplanners, higher performance results can be achieved, as many synthesis tools use this more predictable detailed physical implementation information to establish more aggressive and accurate timing estimates when performing their logic optimizations.

Modular Design

Xilinx innovative modular design capabilities take the incremental design process one step further by enabling the designer to delegate responsibility for completing the design, synthesis, verification, and implementation of a hierarchical "logic block" to an arbitrary number of designers - assigning a specific region within the target FPGA for exclusive use by each of the team members.

This team design capability enables an autonomous approach to design modules, changing the hand-off point to the lead designer or integrator from "my module works in simulation" to "my module works in the FPGA". This unique design methodology also leverages the Xilinx hierarchical floorplanning capabilities and enables the Xilinx (or EDA partner) floorplanner to manage the efficient implementation of very high-density FPGAs.

Table 12: **Register-to-Register Performance *(Continued)***

Description	Device Used & Speed Grade	Register-to-Register Performance	Units
8-bit Adder	XC2V1000 -5	292	MHz
16-bit Adder	XC2V1000 -5	239	MHz
64-bit Adder	XC2V1000 -5	114	MHz
64-bit Counter	XC2V1000 -5	114	MHz
64-bit Accumulator	XC2V1000 -5	110	MHz
Multiplier 18x18 (with Block RAM inputs)	XC2V1000 -5	88	MHz
Multiplier 18x18 (with Register inputs)	XC2V1000 -5	105	MHz
Memory			
Block RAM			
Single-Port 4096 x 4 bits		278	MHz
Single-Port 2048 x 9 bits		277	MHz
Single-Port 1024 x 18 bits		270	MHz
Single-Port 512 x 36 bits		253	MHz
Dual-Port A:4096 x 4 bits & B:1024 x 18 bits		257	MHz
Dual-Port A:1024 x 18 bits & B:1024 x 18 bits		259	MHz
Dual-Port A:2048 x 9 bits & B: 512 x 36 bits		250	MHz
Distributed RAM			
Single-Port 32 x 8-bit	XC2V1000 -5	387	MHz
Single-Port 64 x 8-bit	XC2V1000 -5	335	MHz
Single-Port 128 x 8-bit	XC2V1000 -5	266	MHz
Dual-Port 16 x 8	XC2V1000 -5	409	MHz
Dual-Port 32 x 8	XC2V1000 -5	311	MHz
Dual-Port 64 x 8	XC2V1000 -5	294	MHz
Shift Registers			
128-bit SRL		N/A	MHz
256-bit SRL		N/A	MHz
FIFOs (Async. in Block RAM)			
1024 x 18-bit Read		279	MHz
1024 x 18-bit Write		172	MHz
FIFOs (Sync. in SRL)			
128 x 8-bit		N/A	MHz
128 x 16-bit		N/A	MHz

Date	Version	Revision
07/30/01	1.6	• Updated values in the Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables. • Added values to the Virtex-II Pin-to-Pin Output Parameter Guidelines and Virtex-II Pin-to-Pin Input Parameter Guidelines tables. • Added Frequency Synthesis table.
10/02/01	1.7	• Updated values in the Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables. • Updated the speed grade designations used in data sheets, and added Table 13, which shows the current speed grade designation for each device.
10/05/01	1.8	• Corrected the speed grade designation for the XC2V1000 device in Table 13.
10/12/01	1.9	• Updated values in the Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables.
11/28/01	2.0	• Updated values in Table 3, Table 4, Table 5, Virtex-II Performance Characteristics, and Virtex-II Switching Characteristics tables.
01/03/02	2.1	• Updated values in Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables, based on values extracted from **speedsfile version 1.96**. • Changed the speed grade designation for the XC2V6000 device in Table 13.
07/16/02	2.2	• Updated values in Table 4, "Quiescent Supply Current." • Updated values in Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables, based on values extracted from **speedsfile version 1.111**. • Added Enhanced Multiplier Switching Characteristics section. • Added footnote to Table 37, "Global Clock Setup and Hold for LVTTL Standard, Without DCM." • Added Source-Synchronous Switching Characteristics section.
09/26/02	2.3	• Removed mention of MIL-M-38510/605 specification. • Added footnotes to Table 2 and Table 6.
12/06/02	2.4	• Revised SSTL2 values in Table 6 to match the latest JEDEC specification. • Added footnote regarding V_{IN} PCI compliance to Table 1. • Added footnote regarding CLKOUT_DUTY_CYCLE_DLL to Table 41.
05/07/03	2.5	• Updated values in Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables, based on values extracted from **speedsfile version 1.114**. • Table 4, Quiescent Supply Current, and Table 5, Minimum Power On Current Required for Virtex-II Devices: Added parameters for XC2V8000 device. • Table 16, IOB Output Switching Characteristics: Changed parameter designator T_{IOTON} to T_{IOTP}. • Table 26, Enhanced Multiplier Switching Characteristics: Corrected all parameter designators from $T_{MULT\_P[nn]}$ to $T_{MULT1\_P[nn]}$ in order to correspond with designators used in speedsfile. • Table 27, Enhanced Pipelined Multiplier Switching Characteristics: Corrected all parameter designators from $T_{MULTCK\_P[nn]}$ to $T_{MULTCK1\_P[nn]}$ in order to correspond with designators used in speedsfile. • Removed old Table 19, **Standard Capacitive Loads**. • Added Figure 1, page 17, showing test configuration for measuring I/O standard adjustments.
06/19/03	2.5.1	• Removed footnotes in Table 34 and Table 36 that stated DCM jitter was included in the measurements.

Table 7: **FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000**

Bank	Pin Description	Pin Number	No Connect in XC2V250	No Connect in XC2V500
4	IO_L02N_4/D0/DIN(1)	V18		
4	IO_L02P_4/D1	V17		
4	IO_L03N_4/D2/ALT_VRP_4	W18		
4	IO_L03P_4/D3/ALT_VRN_4	Y18		
4	IO_L04N_4/VREF_4	AA18		
4	IO_L04P_4	AB18		
4	IO_L05N_4/VRP_4	W17		
4	IO_L05P_4/VRN_4	Y17		
4	IO_L06N_4	AA17		
4	IO_L06P_4	AB17		
4	IO_L19N_4	V16	NC	NC
4	IO_L19P_4	V15	NC	NC
4	IO_L21N_4	W16	NC	NC
4	IO_L21P_4/VREF_4	Y16	NC	NC
4	IO_L22N_4	AA16	NC	NC
4	IO_L22P_4	AB16	NC	NC
4	IO_L24N_4	W15	NC	NC
4	IO_L24P_4	Y15	NC	NC
4	IO_L49N_4	AA15	NC	
4	IO_L49P_4	AB15	NC	
4	IO_L51N_4	U14	NC	
4	IO_L51P_4/VREF_4	V14	NC	
4	IO_L52N_4	W14	NC	
4	IO_L52P_4	Y14	NC	
4	IO_L54N_4	AA14	NC	
4	IO_L54P_4	AB14	NC	
4	IO_L91N_4/VREF_4	U13		
4	IO_L91P_4	V13		
4	IO_L92N_4	W13		
4	IO_L92P_4	Y13		
4	IO_L93N_4	AA13		
4	IO_L93P_4	AB13		
4	IO_L94N_4/VREF_4	U12		
4	IO_L94P_4	V12		

Table 8: **FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000**

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
NA	DONE	AD22		
NA	M0	AD4		
NA	M1	AA5		
NA	M2	AD5		
NA	HSWAP_EN	D5		
NA	TCK	E21		
NA	TDI	F5		
NA	TDO	F22		
NA	TMS	D22		
NA	PWRDWN_B	AD23		
NA	DXN	F7		
NA	DXP	C5		
NA	VBATT	C23		
NA	RSVD	C22		
NA	VCCAUX	AD13		
NA	VCCAUX	AC24		
NA	VCCAUX	AC3		
NA	VCCAUX	P24		
NA	VCCAUX	N3		
NA	VCCAUX	D24		
NA	VCCAUX	D3		
NA	VCCAUX	C14		
NA	VCCINT	W19		
NA	VCCINT	W8		
NA	VCCINT	V18		
NA	VCCINT	V17		
NA	VCCINT	V10		
NA	VCCINT	V9		
NA	VCCINT	U18		
NA	VCCINT	U9		
NA	VCCINT	K18		
NA	VCCINT	K9		
NA	VCCINT	J18		
NA	VCCINT	J17		
NA	VCCINT	J10		
NA	VCCINT	J9		

Table 8: **FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000**

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
NA	GND	L11		
NA	GND	L10		
NA	GND	K17		
NA	GND	K16		
NA	GND	K15		
NA	GND	K14		
NA	GND	K13		
NA	GND	K12		
NA	GND	K11		
NA	GND	K10		
NA	GND	F21		
NA	GND	F6		
NA	GND	E22		
NA	GND	E5		
NA	GND	D23		
NA	GND	D4		
NA	GND	C24		
NA	GND	C3		
NA	GND	B25		
NA	GND	B14		
NA	GND	B13		
NA	GND	B2		
NA	GND	A26		
NA	GND	A1		

Notes:
1. See Table 4 for an explanation of the signals available on this pin.

Table 9: **BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
0	IO_L69P_0/VREF_0	B9	NC	
0	IO_L70N_0	F10	NC	
0	IO_L70P_0	E10	NC	
0	IO_L72N_0	A10	NC	
0	IO_L72P_0	A11	NC	
0	IO_L73N_0	C10	NC	NC
0	IO_L73P_0	B10	NC	NC
0	IO_L91N_0/VREF_0	D11		
0	IO_L91P_0	C11		
0	IO_L92N_0	G11		
0	IO_L92P_0	E11		
0	IO_L93N_0	C12		
0	IO_L93P_0	B12		
0	IO_L94N_0/VREF_0	E12		
0	IO_L94P_0	D12		
0	IO_L95N_0/GCLK7P	G12		
0	IO_L95P_0/GCLK6S	F12		
0	IO_L96N_0/GCLK5P	H11		
0	IO_L96P_0/GCLK4S	H12		
1	IO_L96N_1/GCLK3P	A13		
1	IO_L96P_1/GCLK2S	A14		
1	IO_L95N_1/GCLK1P	B13		
1	IO_L95P_1/GCLK0S	C13		
1	IO_L94N_1	D13		
1	IO_L94P_1/VREF_1	E13		
1	IO_L93N_1	F13		
1	IO_L93P_1	G13		
1	IO_L92N_1	H13		
1	IO_L92P_1	H14		
1	IO_L91N_1	C14		
1	IO_L91P_1/VREF_1	D14		
1	IO_L73N_1	E14	NC	NC
1	IO_L73P_1	G14	NC	NC
1	IO_L72N_1	A15	NC	
1	IO_L72P_1	A16	NC	

Table 9: **BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
1	IO_L70N_1	B15	NC	
1	IO_L70P_1	C15	NC	
1	IO_L69N_1/VREF_1	E15	NC	
1	IO_L69P_1	F15	NC	
1	IO_L67N_1	G15	NC	
1	IO_L67P_1	H15	NC	
1	IO_L54N_1	B16		
1	IO_L54P_1	C16		
1	IO_L52N_1	D16		
1	IO_L52P_1	E16		
1	IO_L51N_1/VREF_1	F16		
1	IO_L51P_1	G16		
1	IO_L49N_1	A17		
1	IO_L49P_1	A19		
1	IO_L24N_1	B17		
1	IO_L24P_1	B18		
1	IO_L22N_1	C17		
1	IO_L22P_1	D17		
1	IO_L21N_1/VREF_1	F17		
1	IO_L21P_1	E17		
1	IO_L19N_1	A20		
1	IO_L19P_1	A21		
1	IO_L06N_1	B19		
1	IO_L06P_1	B20		
1	IO_L05N_1	C18		
1	IO_L05P_1	D18		
1	IO_L04N_1	C20		
1	IO_L04P_1/VREF_1	D20		
1	IO_L03N_1/VRP_1	D19		
1	IO_L03P_1/VRN_1	E19		
1	IO_L02N_1	E18		
1	IO_L02P_1	F18		
1	IO_L01N_1	H16		
1	IO_L01P_1	G17		
2	IO_L01N_2	D22		

Table 9: **BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
7	VCCO_7	F3		
NA	CCLK	AB23		
NA	PROG_B	C1		
NA	DONE	AB21		
NA	M0	AC4		
NA	M1	AB4		
NA	M2	AD3		
NA	HSWAP_EN	C2		
NA	TCK	C23		
NA	TDI	D1		
NA	TDO	C24		
NA	TMS	C21		
NA	PWRDWN_B	AC21		
NA	DXN	B4		
NA	DXP	C4		
NA	VBATT	B21		
NA	RSVD	A22		
NA	VCCAUX	AD13		
NA	VCCAUX	AC22		
NA	VCCAUX	AC3		
NA	VCCAUX	N1		
NA	VCCAUX	M24		
NA	VCCAUX	B22		
NA	VCCAUX	B3		
NA	VCCAUX	A12		
NA	VCCINT	U17		
NA	VCCINT	U8		
NA	VCCINT	T16		
NA	VCCINT	T9		
NA	VCCINT	R15		
NA	VCCINT	R14		
NA	VCCINT	R13		
NA	VCCINT	R12		
NA	VCCINT	R11		

Table 10: **BG728 BGA — XC2V3000**

Bank	Pin Description	Pin Number
4	IO_L94P_4	AE14
4	IO_L95N_4/GCLK3S	AF15
4	IO_L95P_4/GCLK2P	AG15
4	IO_L96N_4/GCLK1S	Y14
4	IO_L96P_4/GCLK0P	AA14
5	IO_L96N_5/GCLK7S	AC14
5	IO_L96P_5/GCLK6P	AB14
5	IO_L95N_5/GCLK5S	AG13
5	IO_L95P_5/GCLK4P	AF13
5	IO_L94N_5	AE13
5	IO_L94P_5/VREF_5	AD13
5	IO_L93N_5	AC13
5	IO_L93P_5	AB13
5	IO_L92N_5	AA13
5	IO_L92P_5	Y13
5	IO_L91N_5	W13
5	IO_L91P_5/VREF_5	W12
5	IO_L78N_5	AG12
5	IO_L78P_5	AF12
5	IO_L76N_5	AD12
5	IO_L76P_5	AC12
5	IO_L75N_5/VREF_5	AB12
5	IO_L75P_5	AB11
5	IO_L73N_5	Y12
5	IO_L73P_5	Y11
5	IO_L72N_5	AG11
5	IO_L72P_5	AF11
5	IO_L70N_5	AE11
5	IO_L70P_5	AD11
5	IO_L69N_5/VREF_5	AA10
5	IO_L69P_5	AA11
5	IO_L67N_5	AG10
5	IO_L67P_5	AF10
5	IO_L54N_5	AE10
5	IO_L54P_5	AD10

Table 11: **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
4	IO_L73P_4	AJ12	NC	NC
4	IO_L74N_4	AE13	NC	NC
4	IO_L74P_4	AE14	NC	NC
4	IO_L75N_4	AF13	NC	NC
4	IO_L75P_4/VREF_4	AG13	NC	NC
4	IO_L76N_4	AK13	NC	NC
4	IO_L76P_4	AK12	NC	NC
4	IO_L77N_4	AB14	NC	NC
4	IO_L77P_4	AB15	NC	NC
4	IO_L78N_4	AF15	NC	NC
4	IO_L78P_4	AF14	NC	NC
4	IO_L91N_4/VREF_4	AJ14		
4	IO_L91P_4	AJ15		
4	IO_L92N_4	AC14		
4	IO_L92P_4	AC15		
4	IO_L93N_4	AG15		
4	IO_L93P_4	AG14		
4	IO_L94N_4/VREF_4	AK14		
4	IO_L94P_4	AK15		
4	IO_L95N_4/GCLK3S	AD15		
4	IO_L95P_4/GCLK2P	AE15		
4	IO_L96N_4/GCLK1S	AH14		
4	IO_L96P_4/GCLK0P	AH15		
5	IO_L96N_5/GCLK7S	AH16		
5	IO_L96P_5/GCLK6P	AH17		
5	IO_L95N_5/GCLK5S	AE16		
5	IO_L95P_5/GCLK4P	AD16		
5	IO_L94N_5	AJ16		
5	IO_L94P_5/VREF_5	AJ17		
5	IO_L93N_5	AG17		
5	IO_L93P_5	AG16		
5	IO_L92N_5	AC16		
5	IO_L92P_5	AC17		
5	IO_L91N_5	AK17		
5	IO_L91P_5/VREF_5	AK18		
5	IO_L78N_5	AF17	NC	NC

Table 11: **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
NA	VCCINT	N20		
NA	VCCINT	N11		
NA	VCCINT	M20		
NA	VCCINT	M11		
NA	VCCINT	L20		
NA	VCCINT	L19		
NA	VCCINT	L18		
NA	VCCINT	L17		
NA	VCCINT	L16		
NA	VCCINT	L15		
NA	VCCINT	L14		
NA	VCCINT	L13		
NA	VCCINT	L12		
NA	VCCINT	L11		
NA	VCCINT	K21		
NA	VCCINT	K10		
NA	VCCINT	J22		
NA	VCCINT	J9		
NA	GND	AK23		
NA	GND	AK8		
NA	GND	AJ29		
NA	GND	AJ2		
NA	GND	AH28		
NA	GND	AH21		
NA	GND	AH10		
NA	GND	AH3		
NA	GND	AG27		
NA	GND	AG4		
NA	GND	AF26		
NA	GND	AF19		
NA	GND	AF12		
NA	GND	AF5		
NA	GND	AE25		
NA	GND	AE6		
NA	GND	AD17		
NA	GND	AD14		
NA	GND	AC30		

Table 12: **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
7	VCCO_7	K34	
7	VCCO_7	G31	
NA	CCLK	AH8	
NA	PROG_B	D30	
NA	DONE	AJ7	
NA	M0	AH27	
NA	M1	AJ28	
NA	M2	AK29	
NA	HSWAP_EN	E29	
NA	TCK	F7	
NA	TDI	C31	
NA	TDO	D5	
NA	TMS	E6	
NA	PWRDWN_B	AK6	
NA	DXN	F28	
NA	DXP	G27	
NA	VBATT	C4	
NA	RSVD	G8	
NA	VCCAUX	AM30	
NA	VCCAUX	AM18	
NA	VCCAUX	AM5	
NA	VCCAUX	V3	
NA	VCCAUX	U32	
NA	VCCAUX	C30	
NA	VCCAUX	C17	
NA	VCCAUX	C5	
NA	VCCINT	AD24	
NA	VCCINT	AD11	
NA	VCCINT	AC23	
NA	VCCINT	AC12	
NA	VCCINT	AB22	
NA	VCCINT	AB21	
NA	VCCINT	AB20	
NA	VCCINT	AB19	
NA	VCCINT	AB18	

Table 13: **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
3	IO_L34N_3	AH6	NC	
3	IO_L34P_3	AJ6	NC	
3	IO_L33N_3/VREF_3	AJ8	NC	
3	IO_L33P_3	AH8	NC	
3	IO_L32N_3	AL1	NC	
3	IO_L32P_3	AM1	NC	
3	IO_L31N_3	AH7	NC	
3	IO_L31P_3	AJ7	NC	
3	IO_L30N_3	AH10		
3	IO_L30P_3	AG10		
3	IO_L29N_3	AK3		
3	IO_L29P_3	AL3		
3	IO_L28N_3	AK4		
3	IO_L28P_3	AL4		
3	IO_L27N_3/VREF_3	AJ9		
3	IO_L27P_3	AH9		
3	IO_L26N_3	AM2		
3	IO_L26P_3	AN2		
3	IO_L25N_3	AK5		
3	IO_L25P_3	AL5		
3	IO_L24N_3	AK9		
3	IO_L24P_3	AK8		
3	IO_L23N_3	AN1		
3	IO_L23P_3	AP1		
3	IO_L22N_3	AK6		
3	IO_L22P_3	AL6		
3	IO_L21N_3/VREF_3	AH12		
3	IO_L21P_3	AG12		
3	IO_L20N_3	AM3		
3	IO_L20P_3	AN3		
3	IO_L19N_3	AM4		
3	IO_L19P_3	AN4		
3	IO_L12N_3	AJ12	NC	
3	IO_L12P_3	AH11	NC	
3	IO_L11N_3	AP2	NC	
3	IO_L11P_3	AR2	NC	

Table 13: **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
4	IO_L32P_4	AM14	NC	
4	IO_L33N_4	AT10	NC	
4	IO_L33P_4/VREF_4	AT9	NC	
4	IO_L34N_4	AV10	NC	
4	IO_L34P_4	AV9	NC	
4	IO_L35N_4	AH16	NC	
4	IO_L35P_4	AH17	NC	
4	IO_L36N_4	AP13	NC	
4	IO_L36P_4	AP12	NC	
4	IO_L49N_4	AU12		
4	IO_L49P_4	AU11		
4	IO_L50N_4	AK15		
4	IO_L50P_4	AJ16		
4	IO_L51N_4	AT12		
4	IO_L51P_4/VREF_4	AT11		
4	IO_L52N_4	AN15		
4	IO_L52P_4	AN14		
4	IO_L53N_4	AR12		
4	IO_L53P_4	AR13		
4	IO_L54N_4	AT14		
4	IO_L54P_4	AT13		
4	IO_L55N_4	AW11		
4	IO_L55P_4	AW10		
4	IO_L56N_4	AM15		
4	IO_L56P_4	AM16		
4	IO_L57N_4	AP15		
4	IO_L57P_4/VREF_4	AP14		
4	IO_L58N_4	AV13		
4	IO_L58P_4	AV12		
4	IO_L59N_4	AK16		
4	IO_L59P_4	AK17		
4	IO_L60N_4	AR16		
4	IO_L60P_4	AR15		
4	IO_L67N_4	AW13		
4	IO_L67P_4	AW12		
4	IO_L68N_4	AL16		

Table 13: **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
5	IO_L79N_5	AV24		
5	IO_L79P_5	AV23		
5	IO_L78N_5	AP23		
5	IO_L78P_5	AP22		
5	IO_L77N_5	AJ21		
5	IO_L77P_5	AJ22		
5	IO_L76N_5	AU24		
5	IO_L76P_5	AU23		
5	IO_L75N_5/VREF_5	AT25		
5	IO_L75P_5	AT24		
5	IO_L74N_5	AH21		
5	IO_L74P_5	AH22		
5	IO_L73N_5	AW26		
5	IO_L73P_5	AW25		
5	IO_L72N_5	AR25		
5	IO_L72P_5	AR24		
5	IO_L71N_5	AN23		
5	IO_L71P_5	AN24		
5	IO_L70N_5	AU25		
5	IO_L70P_5	AV25		
5	IO_L69N_5/VREF_5	AL24		
5	IO_L69P_5	AL23		
5	IO_L68N_5	AK23		
5	IO_L68P_5	AK24		
5	IO_L67N_5	AU27		
5	IO_L67P_5	AU26		
5	IO_L60N_5	AP25		
5	IO_L60P_5	AP24		
5	IO_L59N_5	AM24		
5	IO_L59P_5	AM25		
5	IO_L58N_5	AW28		
5	IO_L58P_5	AW27		
5	IO_L57N_5/VREF_5	AT27		
5	IO_L57P_5	AT26		
5	IO_L56N_5	AH23		
5	IO_L56P_5	AH24		

Table 13: **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
6	IO_L47N_6	AJ39		
6	IO_L48P_6	AG35		
6	IO_L48N_6	AH35		
6	IO_L49P_6	AG32		
6	IO_L49N_6	AF32		
6	IO_L50P_6	AH37		
6	IO_L50N_6	AG37		
6	IO_L51P_6	AD29		
6	IO_L51N_6/VREF_6	AE29		
6	IO_L52P_6	AD28		
6	IO_L52N_6	AC28		
6	IO_L53P_6	AH38		
6	IO_L53N_6	AG38		
6	IO_L54P_6	AF34		
6	IO_L54N_6	AG34		
6	IO_L55P_6	AE32		
6	IO_L55N_6	AD32		
6	IO_L56P_6	AH39		
6	IO_L56N_6	AG39		
6	IO_L57P_6	AE33		
6	IO_L57N_6/VREF_6	AF33		
6	IO_L58P_6	AD30		
6	IO_L58N_6	AC30		
6	IO_L59P_6	AF37		
6	IO_L59N_6	AE37		
6	IO_L60P_6	AF36		
6	IO_L60N_6	AG36		
6	IO_L67P_6	AD31		
6	IO_L67N_6	AC31		
6	IO_L68P_6	AE34		
6	IO_L68N_6	AD34		
6	IO_L69P_6	AD35		
6	IO_L69N_6/VREF_6	AE35		
6	IO_L70P_6	AB28		
6	IO_L70N_6	AA28		
6	IO_L71P_6	AF39		

Table 13: **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
7	IO_L50P_7	P32		
7	IO_L50N_7	N32		
7	IO_L49P_7	L37		
7	IO_L49N_7	M37		
7	IO_L48P_7	N34		
7	IO_L48N_7	P34		
7	IO_L47P_7	P31		
7	IO_L47N_7	N31		
7	IO_L46P_7	M35		
7	IO_L46N_7	N35		
7	IO_L45P_7/VREF_7	L36		
7	IO_L45N_7	M36		
7	IO_L44P_7	R28		
7	IO_L44N_7	P28		
7	IO_L43P_7	K39		
7	IO_L43N_7	L39		
7	IO_L36P_7	L34	NC	
7	IO_L36N_7	M34	NC	
7	IO_L35P_7	P29	NC	
7	IO_L35N_7	N29	NC	
7	IO_L34P_7	J38	NC	
7	IO_L34N_7	K38	NC	
7	IO_L33P_7/VREF_7	L33	NC	
7	IO_L33N_7	M33	NC	
7	IO_L32P_7	M32	NC	
7	IO_L32N_7	L32	NC	
7	IO_L31P_7	H39	NC	
7	IO_L31N_7	J39	NC	
7	IO_L30P_7	J36		
7	IO_L30N_7	K36		
7	IO_L29P_7	N30		
7	IO_L29N_7	M30		
7	IO_L28P_7	J37		
7	IO_L28N_7	K37		
7	IO_L27P_7/VREF_7	J35		
7	IO_L27N_7	K35		

Table 13: **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
NA	GND	AC20		
NA	GND	AC19		
NA	GND	AC18		
NA	GND	AC17		
NA	GND	AC16		
NA	GND	AC8		
NA	GND	AC4		
NA	GND	AB24		
NA	GND	AB23		
NA	GND	AB22		
NA	GND	AB21		
NA	GND	AB20		
NA	GND	AB19		
NA	GND	AB18		
NA	GND	AB17		
NA	GND	AB16		
NA	GND	AA24		
NA	GND	AA23		
NA	GND	AA22		
NA	GND	AA21		
NA	GND	AA20		
NA	GND	AA19		
NA	GND	AA18		
NA	GND	AA17		
NA	GND	AA16		
NA	GND	Y39		
NA	GND	Y36		
NA	GND	Y33		
NA	GND	Y30		
NA	GND	Y24		
NA	GND	Y23		
NA	GND	Y22		
NA	GND	Y21		
NA	GND	Y20		
NA	GND	Y19		
NA	GND	Y18		